Power MOSFET -60 V, 43 mΩ, -27 A, P-Channel

Automotive Power MOSFET designed for compact and efficient designs and including high thermal performance.

AEC-Q101 qualified MOSFET and PPAP capable suitable for automotive applications.



- Low On-Resistance
- High Current Capability
- 100% Avalanche Tested
- AEC-Q101 qualified and PPAP capable
- ATPAK package is pin-compatible with DPAK (TO-252)
- Pb-Free, Halogen Free and RoHS compliance

Typical Applications

- Reverse Battery Protection
- Load Switch
- Automotive Front Lighting
- Automotive Body Controllers

SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1)

| Parameter | Symbol | Value | Unit |
|---|----------|-------------|------|
| Drain to Source Voltage | VDSS | -60 | V |
| Gate to Source Voltage | VGSS | ±20 | V |
| Drain Current (DC) | lD | -27 | Α |
| Drain Current (Pulse) PW ≤ 10 µs, duty cycle ≤ 1% | IDP | -81 | Α |
| Power Dissipation Tc = 25°C | PD | 48 | W |
| Operating Junction and Storage Temperature | Tj, Tstg | -55 to +175 | °C |
| Avalanche Energy (Single Pulse) (Note 2) | EAS | 50 | mJ |
| Avalanche Current (Note 3) | lav | -13 | Α |

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 2 : $V_{DD} = -10 \text{ V}$, L = 500 μH , $I_{AV} = -13 \text{ A}$
- 3 : L ≤ 500 μH, Single pulse

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Value | Unit | | | |
|---|-------------------|-------|------|--|--|--|
| Junction to Case Steady State (Tc = 25°C) | R _θ JC | 3.1 | °C/W | | | |
| Junction to Ambient (Note 4) | $R_{\theta JA}$ | 80.5 | °C/W | | | |

Note 4 : Surface mounted on FR4 board using a 130 mm², 1 oz. Cu pad.

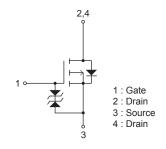


ON Semiconductor®

www.onsemi.com

| VDSS | RDS(on) Max | ID Max |
|-------|----------------|--------|
| | 43 mΩ @ –10 V | |
| –60 V | 59 mΩ @ –4.5 V | –27 A |
| | 63 mΩ @ –4 V | |

ELECTRICAL CONNECTION P-Channel





MARKING



ORDERING INFORMATION

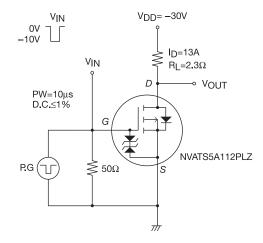
See detailed ordering and shipping information on page 6 of this data sheet.

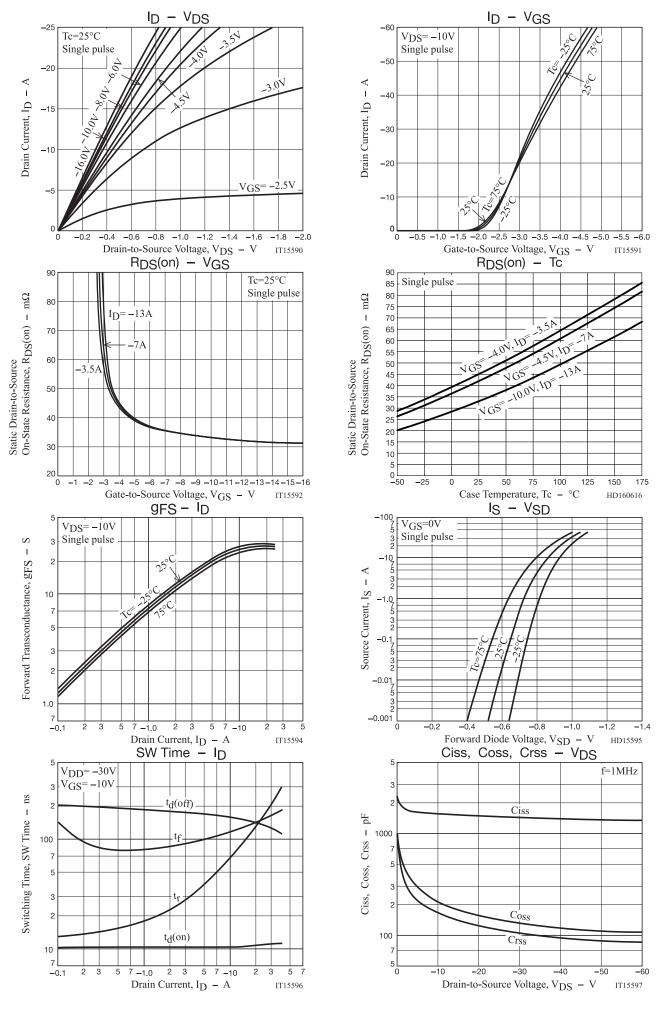
ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 5)

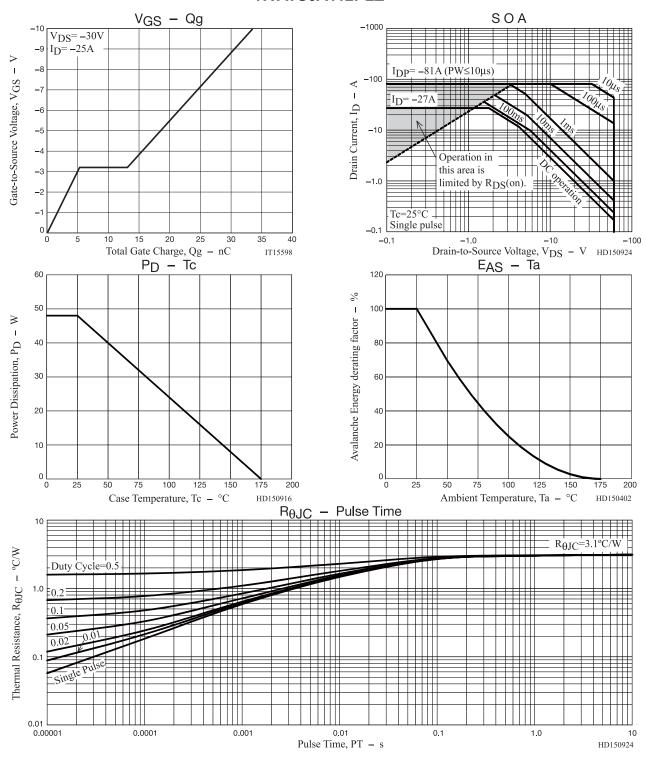
| Darameter | Course In a I | Conditions | Value | | | l lmi4 |
|---|----------------------|--|-------|-------|------|--------|
| Parameter | Symbol | Conditions | min | typ | max | Unit |
| Drain to Source Breakdown Voltage | V(BR)DSS | $I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$ | -60 | | | V |
| Zero-Gate Voltage Drain Current | IDSS | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | -1 | μΑ |
| Gate to Source Leakage Current | IGSS | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±10 | μΑ |
| Gate Threshold Voltage | VGS(th) | $V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$ | -1.2 | | -2.6 | V |
| Forward Transconductance | gFS . | $V_{DS} = -10 \text{ V}, I_{D} = -13 \text{ A}$ | | 24 | | S |
| Static Drain to Source On-State Resistance | | I _D = -13 A, V _{GS} = -10 V | | 33 | 43 | mΩ |
| | R _{DS} (on) | I _D = -7 A, V _{GS} = -4.5 V | | 42 | 59 | mΩ |
| | | I _D = -3.5 A, V _{GS} = -4 V | | 45 | 63 | mΩ |
| Input Capacitance | Ciss | | | 1,450 | | pF |
| Output Capacitance | Coss | V _{DS} = -20 V, f = 1 MHz | | 155 | | pF |
| Reverse Transfer Capacitance | Crss | | | 125 | | pF |
| Turn-ON Delay Time | t _d (on) | | | 10 | | ns |
| Rise Time | t _r | One Fire 4 | | 80 | | ns |
| Turn-OFF Delay Time | t _d (off) | See Fig.1 | | 150 | | ns |
| Fall Time | tf | | | 120 | | ns |
| Total Gate Charge | Qg | V _{DS} = -30 V, V _{GS} = -10 V, I _D = -25 A | | 33.5 | | nC |
| Gate to Source Charge | Qgs | | | 5.3 | | nC |
| Gate to Drain "Miller" Charge | Qgd | | | 7.9 | | nC |
| Forward Diode Voltage | V _{SD} | I _S = -25 A, V _{GS} = 0 V | | -0.97 | -1.5 | V |

Note 5 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Fig.1 Switching Time Test Circuit





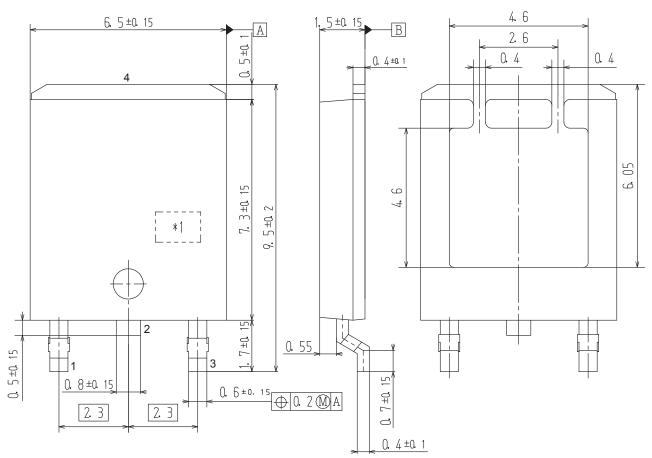


PACKAGE DIMENSIONS

unit: mm

DPAK (Single Gauge) / ATPAK

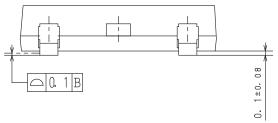
CASE 369AM ISSUE O



1 : Gate 2 : Drain

3 : Source

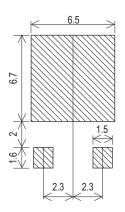
4 : Drain



Pin2 is idle pin with electrical designation only carried

*1:Lot indication

RECOMMENDED SOLDERING FOOTPRINT



ORDERING INFORMATION

| Device | Marking | Package | Shipping (Qty / Packing) |
|------------------|---------|--|--------------------------|
| NVATS5A112PLZT4G | ATP112 | DPAK(Single Gauge) / ATPAK (Pb-Free / Halogen Free) | 3,000 / Tape & Reel |

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage: Since the NVATS5A112PLZ is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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